



Low Cost, Low Noise, CMOS Rail-to-Rail Output Operational Amplifiers

AD8691/AD8692

FEATURES

- Offset voltage: 400 μ V typ
- Low offset voltage drift: 6 μ V/ $^{\circ}$ C max (AD8692)
- Very low input bias currents: 1 pA max
- Low noise: 8 nV/ \sqrt Hz
- Low distortion: 0.0006%
- Wide bandwidth: 10 MHz
- Unity-gain stable
- Single-supply operation: 2.7 V to 6 V

APPLICATIONS

- Photodiode amplification
- Battery-powered instrumentation
- Medical instruments
- Multipole filters
- Sensors
- Portable audio devices

PIN CONFIGURATIONS

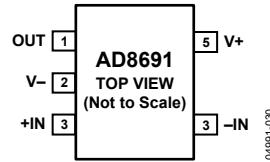


Figure 1. 5-Lead TSOT

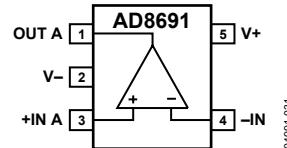


Figure 2. 5-Lead SC70



Figure 3. 8-Lead MSOP

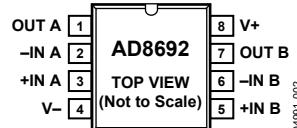


Figure 4. 8-Lead SOIC

GENERAL DESCRIPTION

The AD8691 and AD8692 are low cost, single and dual rail-to-rail output, single-supply amplifiers featuring low offset and input voltages, low current noise, and wide signal bandwidth. The combination of low offset, low noise, very low input bias currents, and high speed make these amplifiers useful in a wide variety of applications. Filters, integrators, photodiode amplifiers, and high impedance sensors all benefit from this combination of performance features. Audio and other ac applications benefit from the wide bandwidth and low distortion of these devices.

Applications for these amplifiers include PA controls, laser diode control loops, portable and loop-powered instrumentation, audio amplification for portable devices, and ASIC input and output amplifiers.

The small SC70 and TSOT package options for the AD8691 allow it to be placed next to sensors, thereby reducing external noise pickup.

The AD8691 and AD8692 are specified over the extended industrial temperature range of -40° C to $+125^{\circ}$ C. The AD8691 is available in 5-lead SC70 and TSOT packages. The AD8692 is available in 8-lead MSOP and narrow SOIC surface-mount packages.

Rev. A

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REVISION HISTORY

1/05 — Rev. 0 to Rev. A

Added AD8691	Universal
Changes to Features.....	1
Added Figure 1 and Figure 2.....	1
Changes to Electrical Characteristics	3
Changes to Figure 6 caption.....	6
Changes to Figure 9.....	6
Updated Outline Dimensions	11
Changes to Ordering Guide	11

10/04—Revision 0: Initial Version

ELECTRICAL CHARACTERISTICS

$V_S = 2.7 \text{ V}$, $V_{CM} = V_S/2$, $T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 1.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	V_{OS}	$V_{CM} = -0.3 \text{ V}$ to $+1.6 \text{ V}$	0.4	2.0	2.0	mV
		$V_{CM} = -0.1 \text{ V}$ to $+1.6 \text{ V}$; $-40^\circ\text{C} < T_A < +125^\circ\text{C}$		3.0	3.0	mV
Input Bias Current	I_B	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$	0.2	1	1	pA
		$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		50	50	pA
Input Offset Current	I_{OS}	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$	0.1	0.5	0.5	pA
		$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		20	20	pA
Input Voltage Range			−0.3	−0.3	+1.6	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = -0.3 \text{ V}$ to $+1.6 \text{ V}$	70	90	90	dB
		$V_{CM} = -0.1 \text{ V}$ to $+1.6 \text{ V}$; $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	65	85	85	dB
Large Signal Voltage Gain	A_{VO}	$R_L = 2 \text{ k}\Omega$, $V_O = 0.5 \text{ V}$ to 2.2 V	90	250	250	V/mV
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$			2	12	$\mu\text{V}/^\circ\text{C}$
AD8691				1.3	6	$\mu\text{V}/^\circ\text{C}$
AD8692						
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	$I_L = 1 \text{ mA}$	2.64	2.66	2.66	V
		$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	2.6			V
Output Voltage Low	V_{OL}	$I_L = 1 \text{ mA}$		25	40	mV
		$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			50	mV
Short-Circuit Current	I_{SC}			±20	±20	mA
Closed-Loop Output Impedance	Z_{OUT}	$f = 1 \text{ MHz}$, $A_V = 1$		12	12	Ω
POWER SUPPLY						
Power-Supply Rejection Ratio	PSRR	$V_S = 2.7 \text{ V}$ to 5.5 V	80	95	95	dB
		$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	75	95	95	dB
Supply Current/Amplifier	I_{SY}	$V_O = 0 \text{ V}$		0.85	0.95	mA
		$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			1.2	mA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 2 \text{ k}\Omega$	5	5	5	$\text{V}/\mu\text{s}$
Settling Time	t_s	To 0.01%	1	1	1	μs
Gain Bandwidth Product	GBP		10	10	10	MHz
Phase Margin	ϕ_o		60	60	60	Degrees
Total Harmonic Distortion + Noise	THD + N	$G = 1$, $R_L = 600 \text{ }\Omega$, $f = 1 \text{ kHz}$, $V_O = 250 \text{ mV p-p}$	0.003	0.003	0.003	%
NOISE PERFORMANCE						
Voltage Noise	$e_{n,p-p}$	$f = 0.1 \text{ Hz}$ to 10 Hz	1.6	3.0	3.0	$\mu\text{V p-p}$
Voltage Noise Density	e_n	$f = 1 \text{ kHz}$	8	12	12	$\text{nV}/\sqrt{\text{Hz}}$
	e_n	$f = 10 \text{ kHz}$	6.5	6.5	6.5	$\text{nV}/\sqrt{\text{Hz}}$
Current Noise Density	i_n	$f = 1 \text{ kHz}$	0.05	0.05	0.05	$\text{pA}/\sqrt{\text{Hz}}$

AD8691/AD8692

$V_S = 5.0 \text{ V}$, $V_{CM} = V_S/2$, $T_A = 5^\circ\text{C}$, unless otherwise noted.

Table 2.

Parameter	Symbol	Conditions	A Grade		
			Min	Typ	Max
INPUT CHARACTERISTICS					
Offset Voltage	V_{OS}	$V_{CM} = -0.3 \text{ V to } +3.9 \text{ V}$ $V_{CM} = -0.1 \text{ V to } +3.9 \text{ V}; -40^\circ\text{C} < T_A < +125^\circ\text{C}$	0.4	2.0	mV
Input Bias Current	I_B	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	0.2	1	pA
Input Offset Current	I_{OS}	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	0.1	0.5	pA
Input Voltage Range				20	pA
Common-Mode Rejection Ratio	CMRR	$V_{CM} = -0.3 \text{ V to } +3.9 \text{ V}$ $V_{CM} = -0.1 \text{ V to } +3.9 \text{ V}; -40^\circ\text{C} < T_A < +125^\circ\text{C}$	75	95	dB
Large Signal Voltage Gain	A_{VO}	$V_O = 0.5 \text{ V to } 4.5 \text{ V}, R_L = 2 \text{ k}\Omega, V_{CM} = 0 \text{ V}$	70	95	dB
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$		250	2000	V/mV
AD8691			2	12	$\mu\text{V}/^\circ\text{C}$
AD8692			1.3	6	$\mu\text{V}/^\circ\text{C}$
OUTPUT CHARACTERISTICS					
Output Voltage High	V_{OH}	$I_L = 1 \text{ mA}$ $I_L = 10 \text{ mA}$ $-40^\circ\text{C} \text{ to } +125^\circ\text{C}$	4.96	4.98	V
Voltage Low	V_{OL}	$I_L = 1 \text{ mA}$ $I_L = 10 \text{ mA}$ $-40^\circ\text{C} \text{ to } +125^\circ\text{C}$	4.7	4.78	V
Short-Circuit Current	I_{SC}		4.6	40	V
Closed-Loop Output Impedance	Z_{OUT}	$f = 1 \text{ MHz}, A_V = 1$	16.5	210	mV
			165	290	mV
			± 80		mA
			10		Ω
POWER SUPPLY					
Power Supply Rejection Ratio	PSRR	$V_S = 2.7 \text{ V to } 5.5 \text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	80	95	dB
Supply Current/Amplifier	I_{SY}	$V_O = 0 \text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	75	95	dB
			0.95	1.05	mA
			1.3		mA
DYNAMIC PERFORMANCE					
Slew Rate	SR	$R_L = 2 \text{ k}\Omega$	5		$\text{V}/\mu\text{s}$
Settling Time	t_s	To 0.01%	1		μs
Full Power Bandwidth	BW_P	<1% distortion	360		kHz
Gain Bandwidth Product	GBP		10		MHz
Phase Margin	ϕ_o		65		Degrees
Total Harmonic Distortion + Noise	THD + N	$G = 1, R_L = 600 \Omega, f = 1 \text{ kHz}, V_O = 1 \text{ V p-p}$	0.0006		%
NOISE PERFORMANCE					
Voltage Noise	$e_{n,p-p}$	$f = 0.1 \text{ Hz to } 10 \text{ Hz}$	1.6	3.0	$\mu\text{V p-p}$
Voltage Noise Density	e_n	$f = 1 \text{ kHz}$	8	12	$\text{nV}/\sqrt{\text{Hz}}$
Current Noise Density	i_n	$f = 10 \text{ kHz}$	6.5		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 1 \text{ kHz}$	0.05		$\text{pA}/\sqrt{\text{Hz}}$

ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 3.

Parameters	Ratings
Supply Voltage	6 V
Input Voltage	$V_{SS} - 0.3 \text{ V}$ to $V_{DD} + 0.3 \text{ V}$
Differential Input Voltage	$\pm 6 \text{ V}$
Output Short-Circuit Duration to GND	Observe derating curves
Storage Temperature Range	-65°C to $+150^\circ\text{C}$
Operating Temperature Range	-40°C to $+125^\circ\text{C}$
Junction Temperature Range	-65°C to $+150^\circ\text{C}$
Lead Temperature Range (Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

Table 4.

Package Type	θ_{JA} ¹	θ_{JC}	Unit
8-Lead MSOP (RM)	210	45	°C/W
8-Lead SOIC (R)	158	43	°C/W
5-Lead TSOT (UJ-5)	207	61	°C/W
5-Lead SC70 (KS)	376	126	°C/W

¹ θ_{JA} is specified for the worst-case conditions, that is, the device soldered in the circuit board for surface-mount packages.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



AD8691/AD8692

TYPICAL PERFORMANCE CHARACTERISTICS

$V_S = +5\text{ V}$ or $\pm 2.5\text{ V}$, unless otherwise noted.

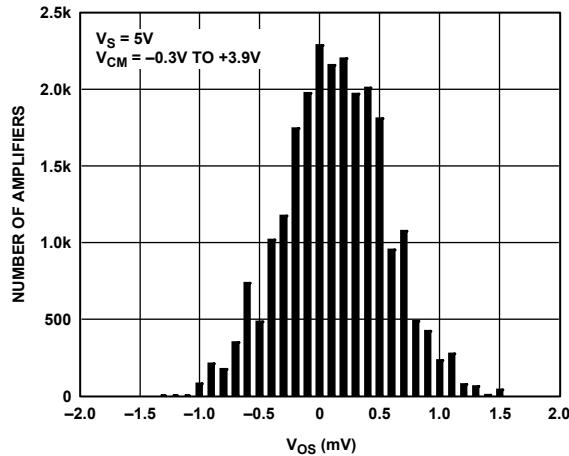


Figure 5. Input Offset Voltage Distribution

04991-003

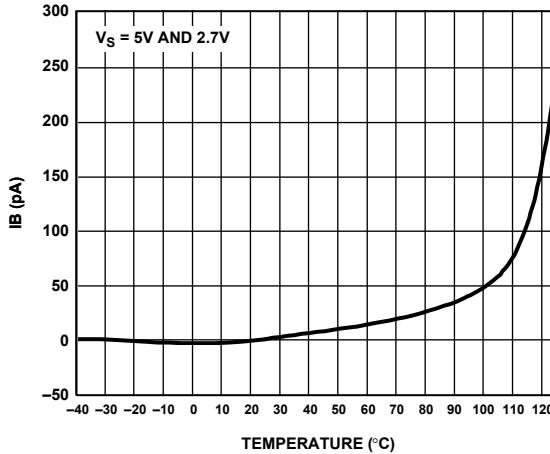


Figure 8. Input Bias Current vs. Temperature

04991-006

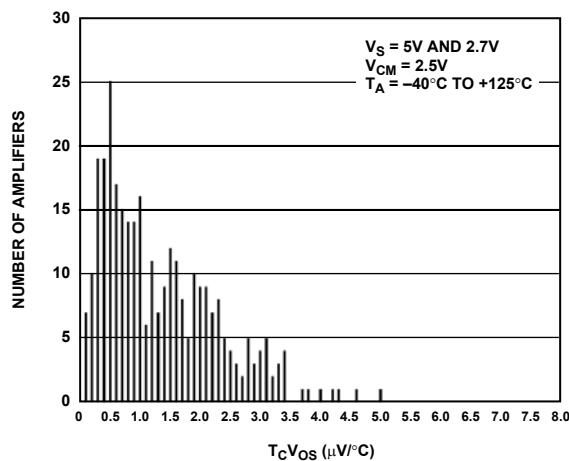


Figure 6. AD8692 Input Offset Voltage Drift Distribution

04991-004

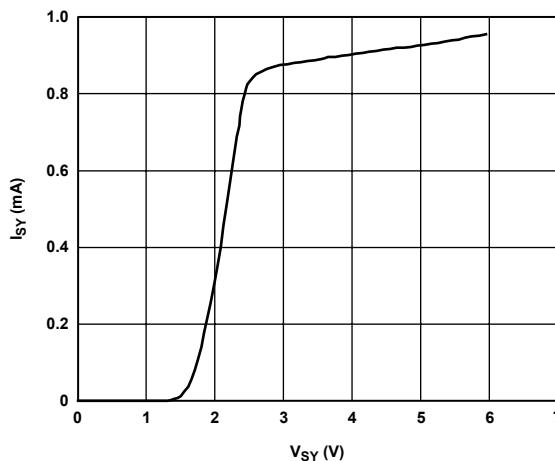


Figure 9. Supply Current vs. Supply Voltage

04991-007

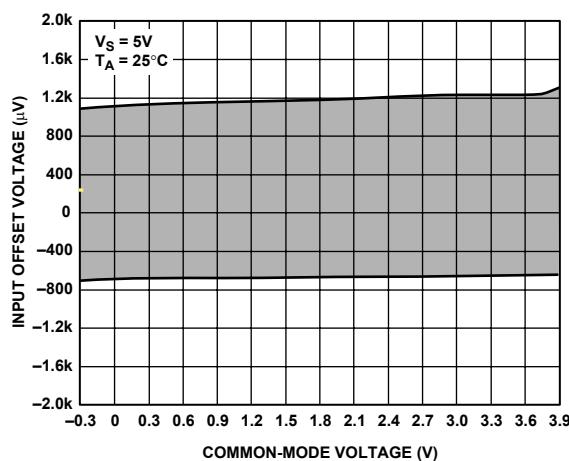


Figure 7. Input Offset Voltage vs. Common-Mode Voltage

04991-005

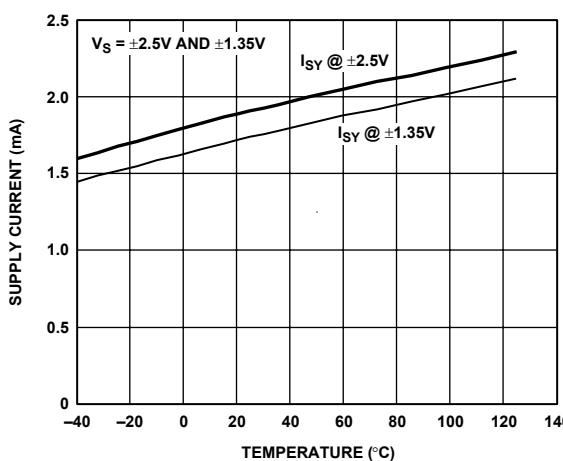


Figure 10. Supply Current vs. Temperature

04991-008

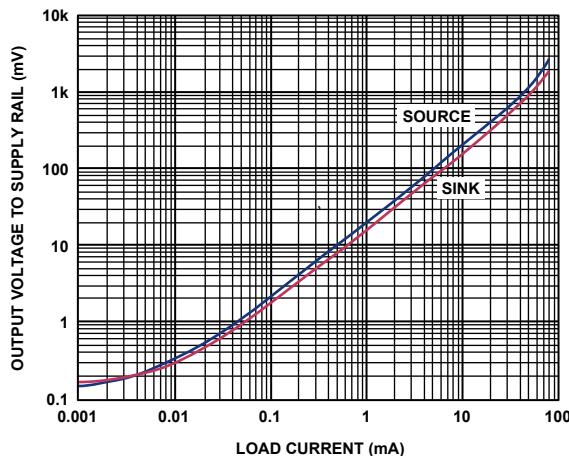


Figure 11. Output Voltage to Supply Rail vs. Load Current

04991-009

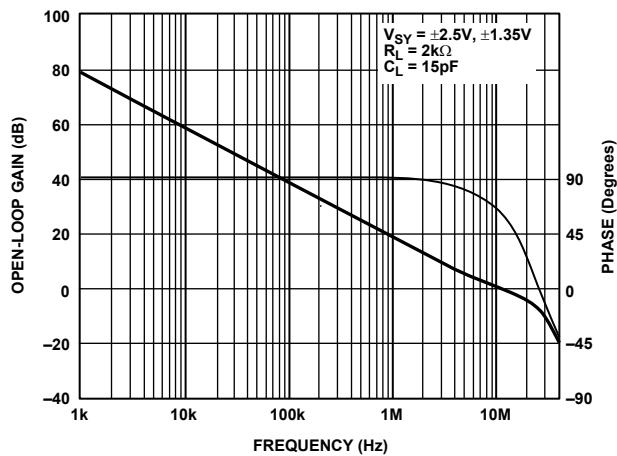
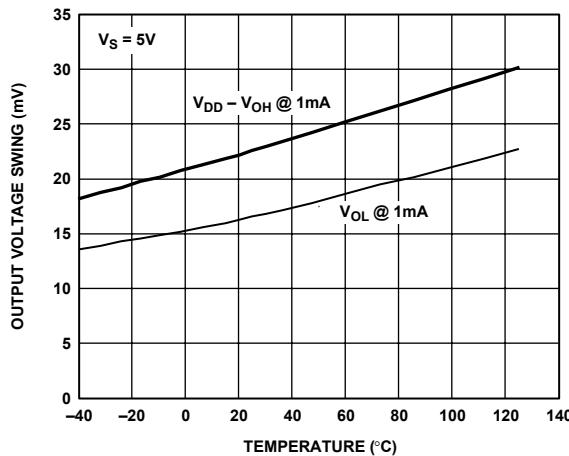


Figure 14. Open-Loop Gain and Phase vs. Frequency

04991-012

Figure 12. Output Voltage Swing vs. Temperature ($I_L = 1\text{ mA}$)

04991-010

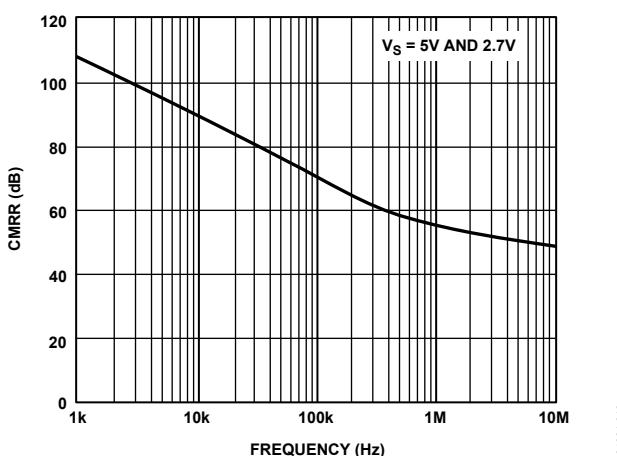
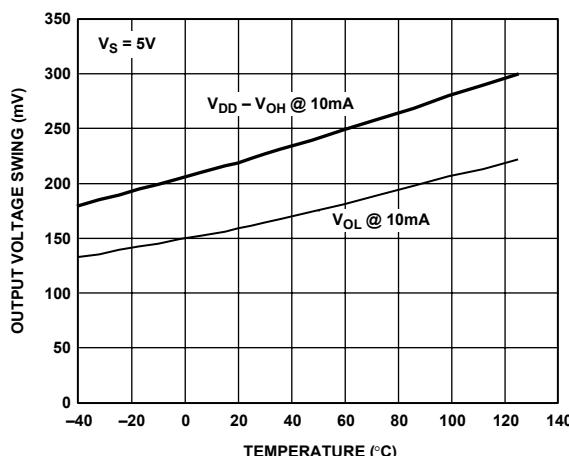


Figure 15. CMRR vs. Frequency

04991-013

Figure 13. Output Voltage Swing vs. Temperature ($I_L = 10\text{ mA}$)

04991-011

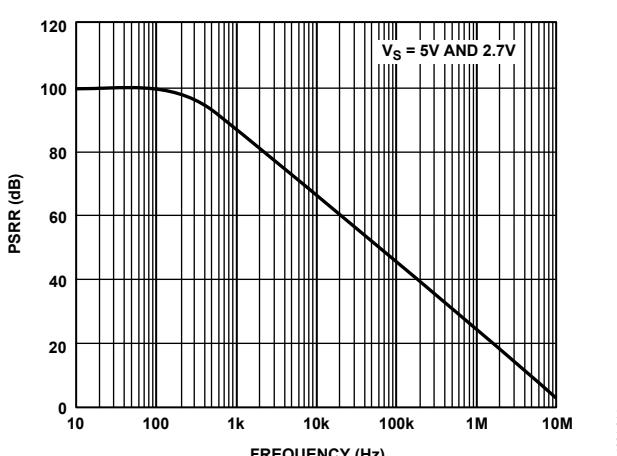


Figure 16. PSRR vs. Frequency

04991-014

AD8691/AD8692

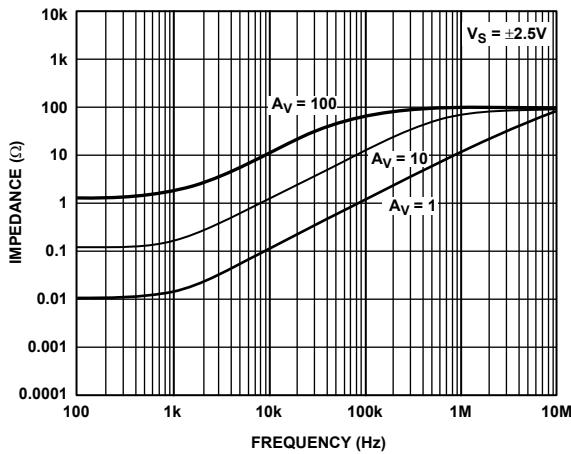


Figure 17. Closed-Loop Output Impedance vs. Frequency

04991-015

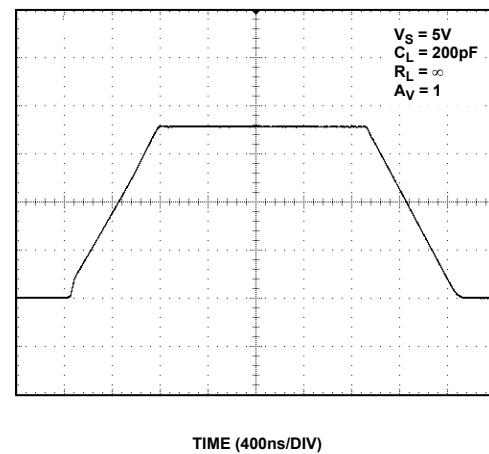


Figure 20. Large Signal Transient Response

04991-016

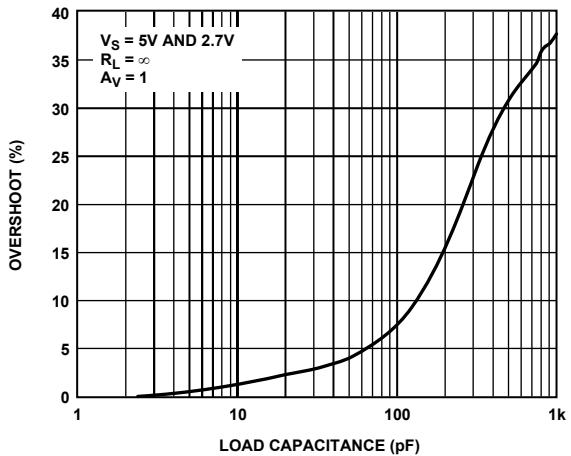


Figure 18. Small Signal Overshoot vs. Load Capacitance

04991-016

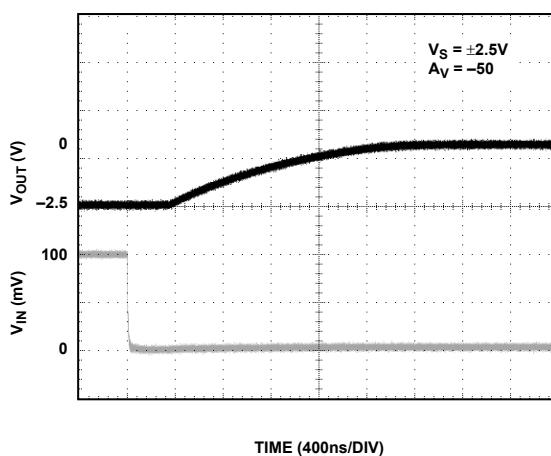


Figure 21. Positive Overload Recovery

04991-019

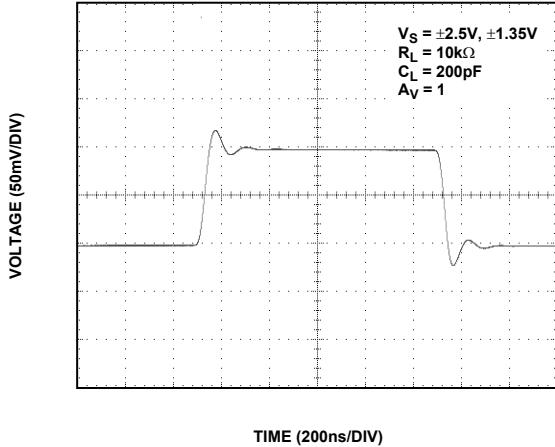


Figure 19. Small Signal Transient Response

04991-017

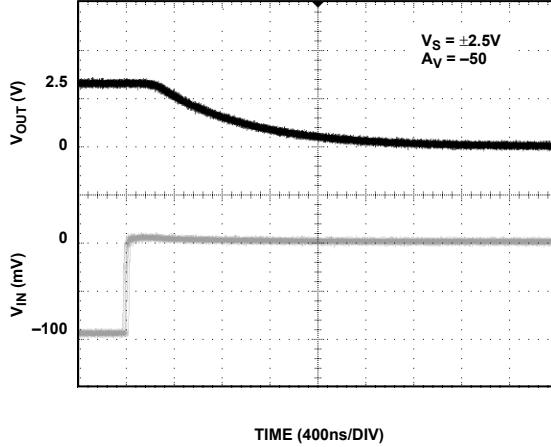


Figure 22. Negative Overload Recovery

04991-020

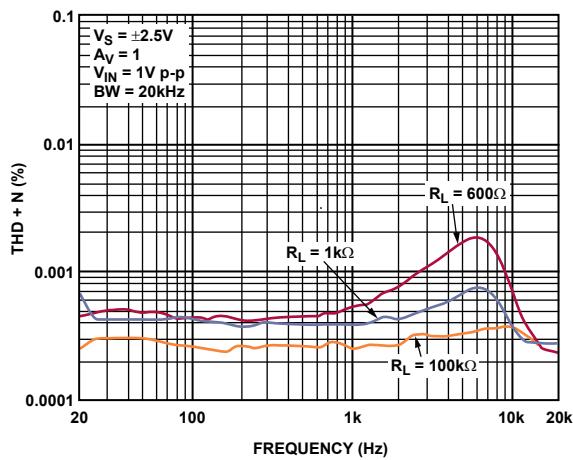


Figure 23. THD + N vs. Frequency

04991-021

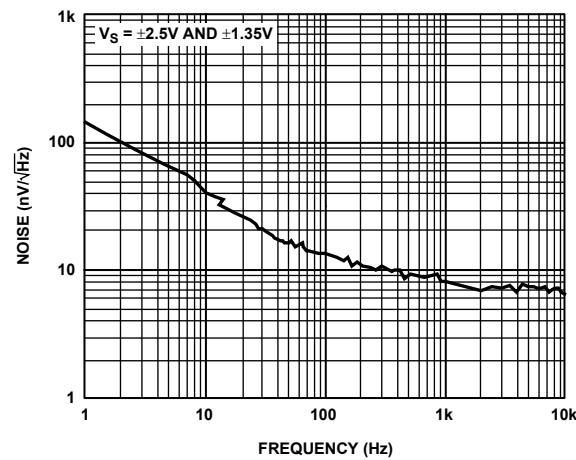


Figure 25. Voltage Noise Density

04991-023

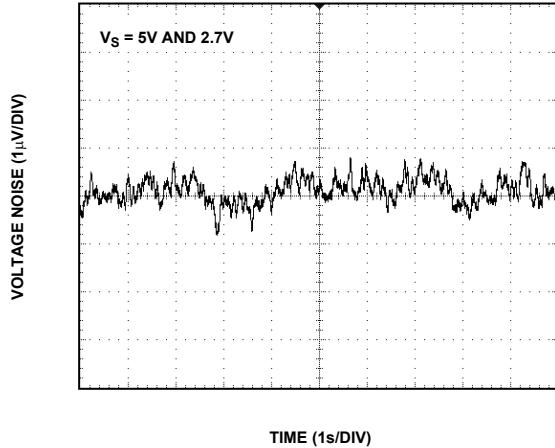


Figure 24. 0.1 Hz to 10 Hz Input Voltage Noise

04991-022

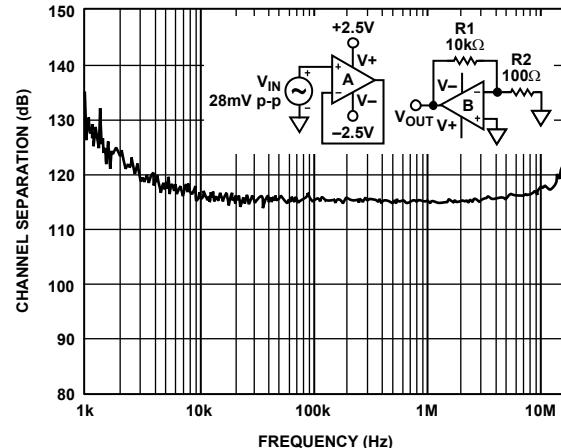


Figure 26. AD8692 Channel Separation

04991-024

AD8691/AD8692

$V_S = +2.7\text{ V}$ or $\pm 1.35\text{ V}$, unless otherwise noted.

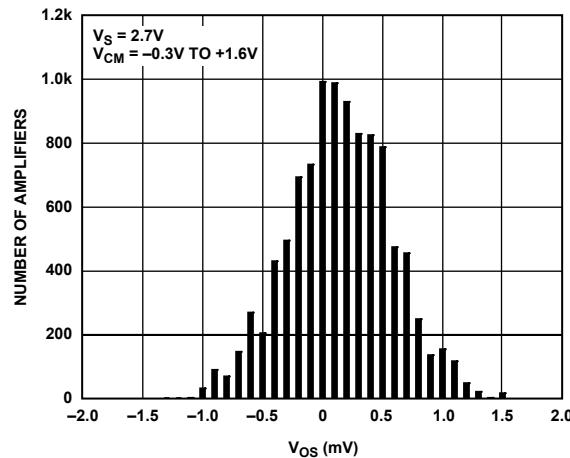


Figure 27. Input Offset Voltage Distribution

04991-025

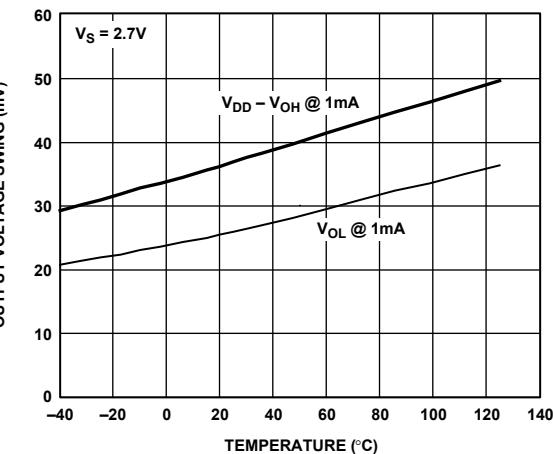


Figure 30. Output Voltage Swing vs. Temperature

04991-028

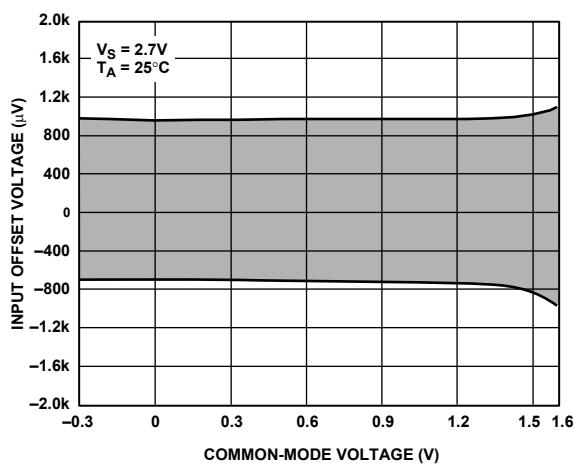


Figure 28. Input Offset Voltage vs. Common-Mode Voltage

04991-026

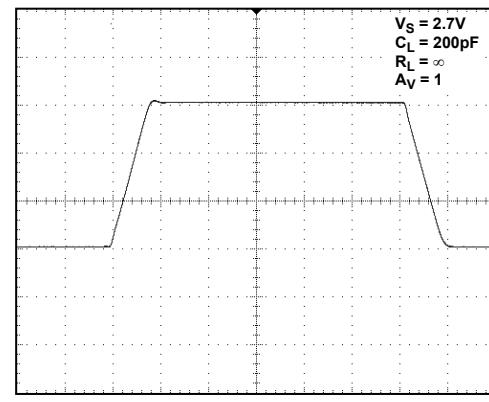
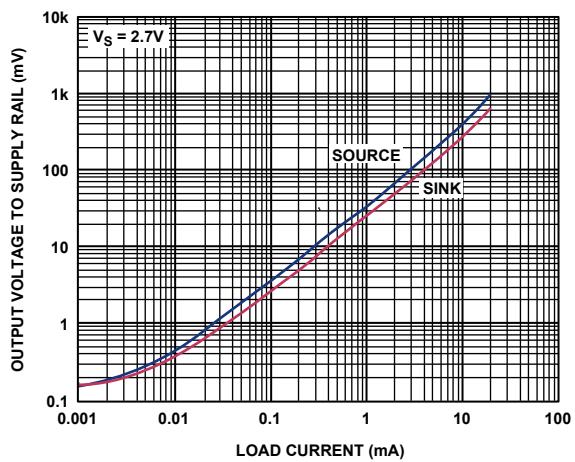


Figure 31. Large Signal Transient Response

04991-029



04991-027

Figure 29. Output Voltage to Supply Rail vs. Load Current

OUTLINE DIMENSIONS

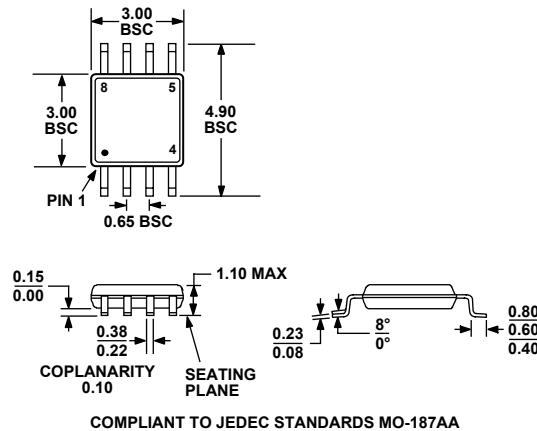
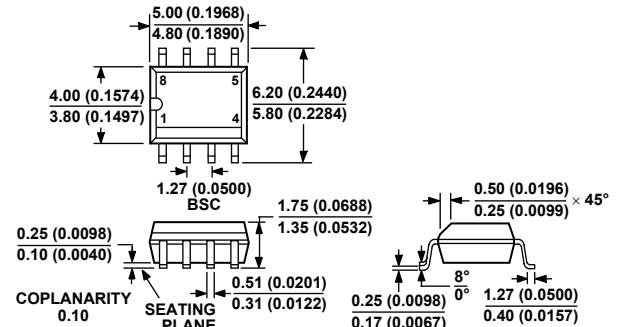


Figure 32. 8-Lead Mini Small Outline Package [MSOP]
(RM-8)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 34. 8-Lead Standard Small Outline Package [SOIC]
Narrow Body (R-8)

Dimensions shown in millimeters and (inches)

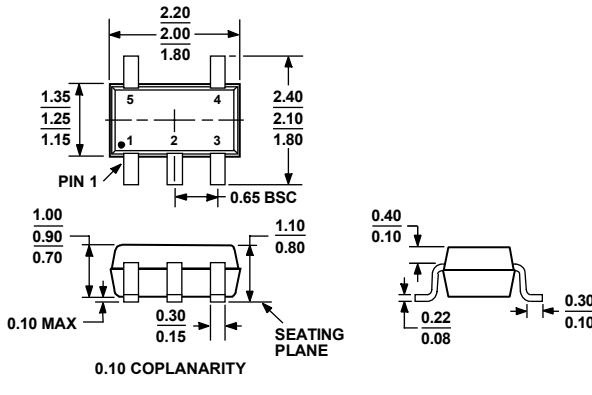
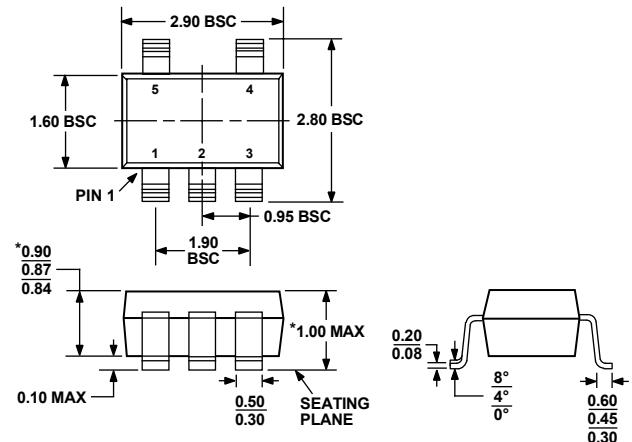


Figure 33. 5-Lead Thin Shrink Small Outline Package [SC70]
(KS-5)

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-193-AB WITH
THE EXCEPTION OF PACKAGE HEIGHT AND THICKNESS.

Figure 35. 5-Lead Thin Small Outline Transistor Package [TSOT]
(UJ-5)

Dimensions shown in millimeters

AD8691/AD8692

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
AD8691AUJZ-R2 ¹	–40°C to +125°C	5-Lead TSOT	UJ-5	ACA
AD8691AUJZ-REEL ¹	–40°C to +125°C	5-Lead TSOT	UJ-5	ACA
AD8691AUJZ-REEL7 ¹	–40°C to +125°C	5-Lead TSOT	UJ-5	ACA
AD8691AKSZ-R2 ¹	–40°C to +125°C	5-Lead SC70	KS-5	ACA
AD8691AKSZ-REEL ¹	–40°C to +125°C	5-Lead SC70	KS-5	ACA
AD8691AKSZ-REEL7 ¹	–40°C to +125°C	5-Lead SC70	KS-5	ACA
AD8692ARMZ-R2 ¹	–40°C to +125°C	8-Lead MSOP	RM-8	APA
AD8692ARMZ-REEL ¹	–40°C to +125°C	8-Lead MSOP	RM-8	APA
AD8692ARZ ¹	–40°C to +125°C	8-Lead SOIC	R-8	
AD8692ARZ-REEL ¹	–40°C to +125°C	8-Lead SOIC	R-8	
AD8692ARZ-REEL7 ¹	–40°C to +125°C	8-Lead SOIC	R-8	

¹ Z = Pb-free part.